



FOR IMMEDIATE RELEASE

Soitec appoints Deputy Finance Director

BERNIN, France, April 15, 2009 — Soitec (Euronext Paris), the world's leading supplier of engineered substrates for microelectronics, today announced that Olivier Brice has been named Deputy Finance Director and will assume direct responsibility for the overall day to day management of the Finance Department, in addition to his existing duties as manager of investor relations, financial communication and group treasury.

Iain Murray will continue to act as Chief Financial Officer, advising the Company's President, Andre-Jacques Auberton-Hervé, with respect to the Company's strategic initiatives and long-term financial development

Brice (49) joined Soitec in 2005 initially to take responsibility for investor relations and financial communications and subsequently management of the group treasury function. He holds a BA in management and graduated from Sciences Po Paris, before starting his professional career as a banker. Brice then joined the Carbone Lorraine group, starting in investor relations before seeing his responsibilities extended to treasury and finance. Between 2001 and 2005, he was a manager of Gavin Anderson & Co., a financial communication firm.

Murray (57) joined Soitec in 1996 as Chief Financial Officer and has played an integral role in the Company's development since then, including the original joint venture with SEH, the Company's initial and subsequent offerings on the Paris Stock Exchange and the development of its production facilities at Bernin I, II, III and Pasir Ris in Singapore.

About Soitec

Soitec is the world's leading supplier of engineered substrates for advanced microelectronics. The Group produces a wide range of advanced materials, especially silicon-on-insulator (SOI) wafers based on its Smart Cut™ technology—the first high-volume application for this proprietary technology. SOI is currently seen as the platform of the future, paving the way to higher-performance, faster, and more economical chips.

Soitec currently produces over 80% of SOI wafers. Headquartered at Bernin in France, with two high-volume production units on site, Soitec also has offices in the US, Japan, and Taiwan, and a new production site is in the process of customers qualification in Singapore.

The Group has two other divisions: Picogiga International at Les Ulis in Paris and Tracit Technologies in Bernin. Picogiga is specialized in the development and manufacture of engineered substrates, from group III-V epitaxial semiconductor wafers and gallium nitride (GaN) wafers to composite substrates for the manufacture of high-frequency electronics and optoelectronic devices. Tracit is specialized in thin-film layer transfer technologies, used to manufacture engineered substrates for power ICs and microsystems, as well as generic circuit transfer technology for applications such as image sensors and 3D integration. Shares for the Soitec Group are listed on Euronext Paris. More information is available at www.soitec.com

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